

UFS1200

SURFACE MOUNT FAST SWITCHING RECTIFIER

VOLTAGE: 1200V

CURRENT: 1.0A



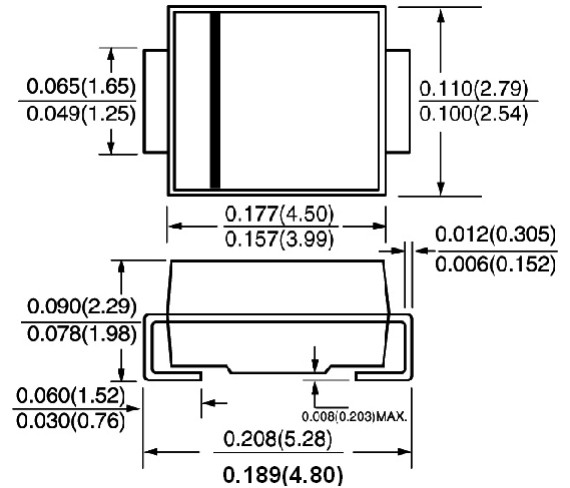
FEATURE

Low power loss
High surge capability
Glass passivated chip junction
Fast recovery time for high efficiency
High temperature soldering guaranteed
260°C/10sec/at terminals

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: color band denotes cathode
Marking: UF12

SMA / DO-214AC



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

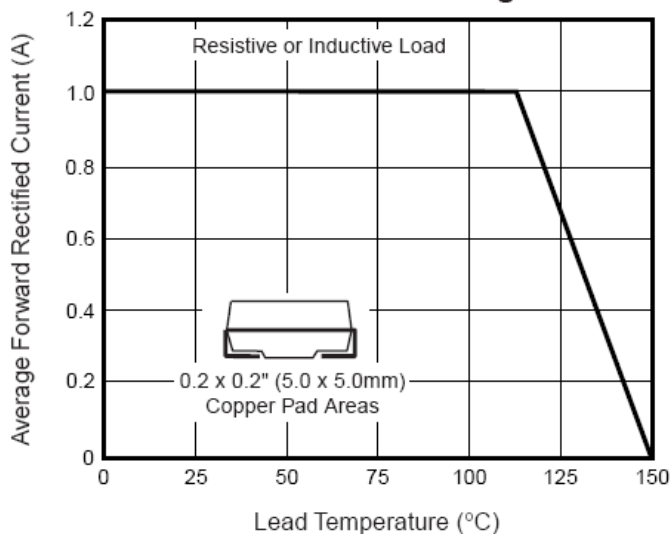
(single-phase, half -wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	Symbol	UFS1200	units
Maximum Recurrent Peak Reverse Voltage	V _{rrm}	1200	V
Maximum RMS Voltage	V _{rms}	840	V
Maximum DC blocking Voltage	V _{dc}	1200	V
Maximum Average Forward Rectified Current	I _{f(av)}	1.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{fsm}	30.0	A
Maximum Forward Voltage at Forward current 1A Peak	V _f	1.5	V
Maximum DC Reverse Current at rated DC blocking voltage	I _r	10.0 100.0	μA
Maximum Reverse Recovery Time	T _{rr}	100	nS
Typical Junction Capacitance	C _j	15	pF
Typical Thermal Resistance	R _{th(ja)} R _{th(jl)} R _{th(jc)}	75 30 53	°C/W
Storage and Operating Junction Temperature	T _{stg} , T _j	-55 to +150	°C

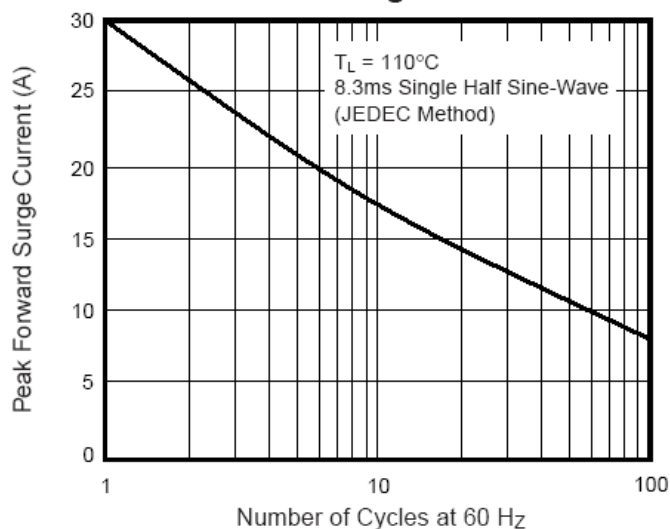
- Note:
1. Reverse Recovery Condition I_f = 0.5A, I_r = 1.0A, I_{rr} = 0.25A
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
 3. Thermal Resistance from Junction to ambient and from Junction to terminal mounted on 5 × 5mm copper pad area
 4. Thermal Resistance from Junction to case

RATINGS AND CHARACTERISTIC CURVES UFS1200

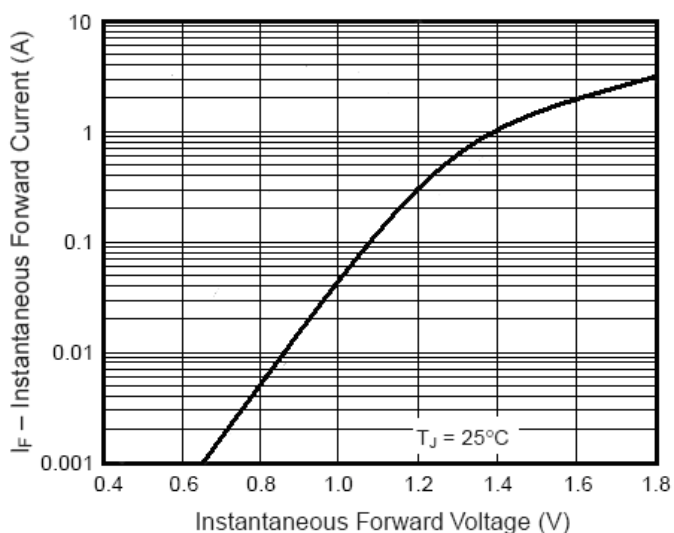
Forward Current Derating Curve



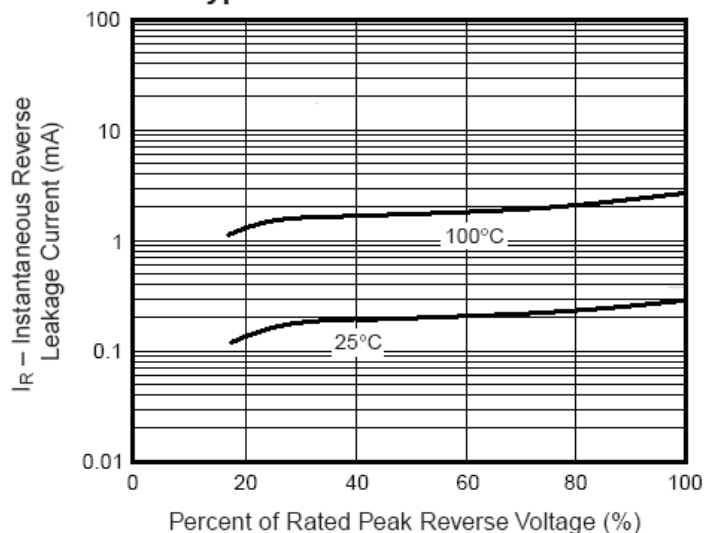
Maximum Non-Repetitive Peak Forward Surge Current



Typical Instantaneous Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance

